# FP1505

# High frequency, high current power inductors



#### **Product features**

- 7.0 x 15.0 x 5.0mm surface mount package
- Ferrite core material
- · High current handling capability, low core loss
- Designed for high speed, high current switch mode applications
- Tight DCR tolerance for sensing circuits
- Inductance range from 100 nH to 400 nH
- Current range from 24 A to 105 A
- Frequency range up to 1 MHz

#### **Applications**

- Multi-phase regulators
- Voltage Regulator Module (VRM)
- Desktop and server VRMs and EVRDs
- Data networking and storage systems
- Notebook regulators
- Graphics cards and battery power systems
- Point of load modules
- DCR current sensing

#### **Environmental data**

- Storage temperature range (component):
   -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature:
   J-STD-020 (latest revision) compliant









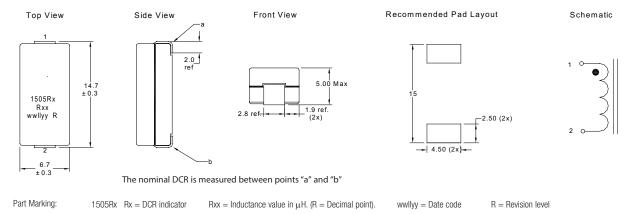
## **Product specifications**

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Part	OCL1	FLL <sup>2</sup>	l <sub>rms</sub> °	l <sub>sat</sub> 1⁴	l <sub>sat</sub> 2⁵	DCR (m $\Omega$ )	
Number <sup>7</sup>	± 10% (nH)	Min. (nH)	(A)	(A) @+25 °C	(Amps) @+125 °C	@+20 °C	K-factor <sup>6</sup>
FP1505R1-R10-R	100	72		105	90		356.3
FP1505R1-R12-R	120	86		87	75		356.3
FP1505R1-R15-R	150	108	53	72	60	$0.47 \pm 7\%$	356.3
FP1505R1-R25-R	250	180	55	42	32	U.47 ± 1 /0	356.3
FP1505R1-R30-R	300	217		35	26		356.3
FP1505R1-R40-R	400	288		24	19.5		356.3

- 1 Open Circuit Inductance (OCL) Test Parameters: 100 kHz, 1.0 V<sub>rms</sub>, 0.0 Adc
- 2 Full Load Inductance (FLL) Test Parameters: 100 kHz, 1.0 V<sub>rms</sub>. I<sub>sat</sub>1
  3 I<sub>rms</sub>: DC current for an approximate temperature rise of 40 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +125 °C under worst case operating conditions verified in the end application.
- 4 I<sub>sat</sub>1: Peak current for approximately 20% rolloff at +25 °C.

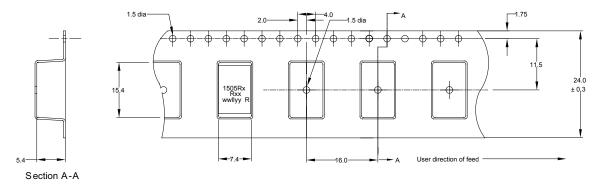
- 5 I<sub>sat</sub>2: Peak current for approximately 20% rolloff at +125 °C.
- Saturation: Used to determine  $B_{p-p}$  for core loss (see graph).  $B_{p-p} = K * L * \Delta I * 10^3$ .  $B_{p-p}$ :(Gauss), K: (K-factor from table), L: (Inductance in nH),  $\Delta I$  (Peak-to-peak ripple current in amps).
- 7 Part Number Definition: FP1505Rx-Rxx-R
  - FP1505 = Product code and size
  - Rx= DCR indicator
  - Rxx= Inductance value in uH, R = decimal point
  - -R suffix = RoHS compliant

#### **Dimensions- mm**



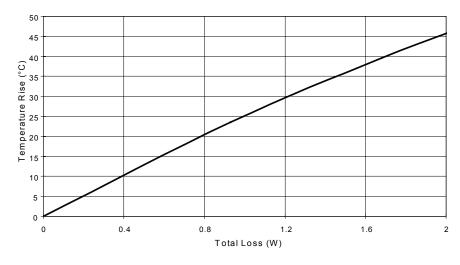
Do not route traces or vias underneath the inductor

### Packaging information - mm

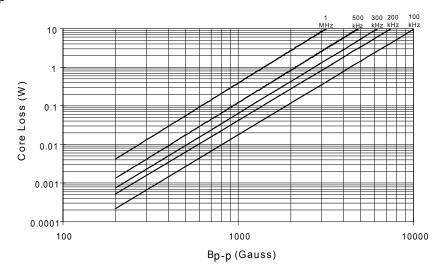


Supplied in tape-and-reel packaging, 744 parts per reel, 13" diameter reel.

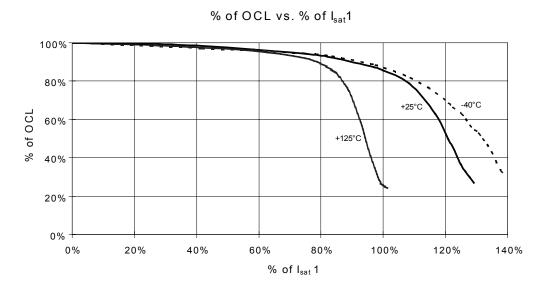
# Temperature rise vs total loss



# Core loss vs Bp-p



# **Inductance characteristics**



### **Solder Reflow Profile**

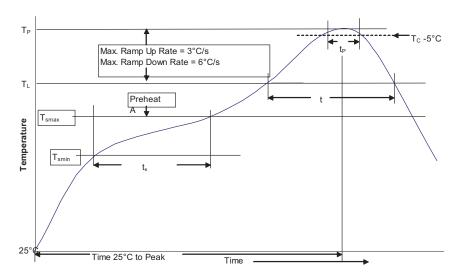


Table 1 - Standard SnPb Solder (T<sub>c</sub>)

	Volume	Volume
Package	mm³	mm³
Thickness	<350	≥350
<2.5mm	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (Tc)

	Volume	Volume	Volume
Package	mm³	mm³	mm <sup>3</sup>
Thickness	<350	350 - 2000	>2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

#### **Reference JDEC J-STD-020**

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak	• Temperature min. (T <sub>smin</sub> )	100°C	150°C
	Temperature max. (T <sub>smax</sub> )	150°C	200°C
	• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 Seconds	60-120 Seconds
Average ramp up ra	te T <sub>smax</sub> to T <sub>p</sub>	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (TL)		183°C	217°C
Time at liquidous (t <sub>L</sub> )		60-150 Seconds	60-150 Seconds
Peak package body	temperature (T <sub>P</sub> )*	Table 1	Table 2
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature $(T_c)$		20 Seconds**	30 Seconds**
Average ramp-down	rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.

 $<sup>^{\</sup>star}$  Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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<sup>\*\*</sup> Tolerance for time at peak profile temperature  $(t_p)$  is defined as a supplier minimum and a user maximum.